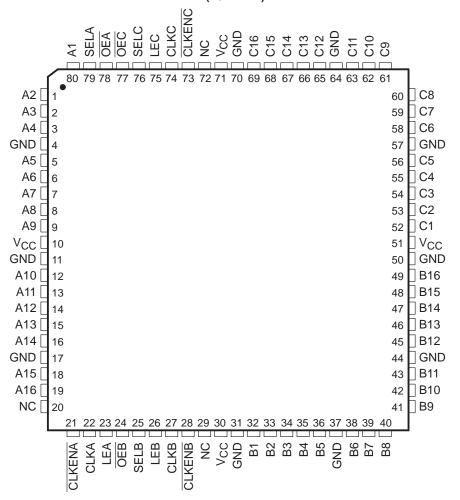
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- **Members of the Texas Instruments** Widebus+™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- **UBE** ™ (Universal Bus Exchanger) **Combines D-Type Latches and D-Type** Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) $< 0.8 \text{ V at V}_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

- **High-Impedance State During Power Up** and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With 12 × 12-mm Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package

'ABTH32316 . . . PN PACKAGE (TOP VIEW)

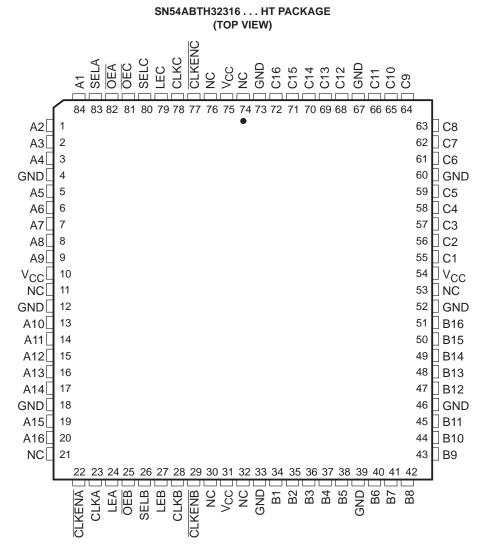




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NC - No internal connection

description

The 'ABTH32316 consist of three 16-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA and clock-enable A (\overline{CLKENA}) are low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



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description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABTH32316 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH32316 is characterized for operation from –40°C to 85°C.

Function Tables

STORAGE[†]

	INPUTS					
CLKENA	KENA CLKA LEA A					
Н	Х	L	Χ	Q ₀ ‡		
L	\uparrow	L	L	L		
L	\uparrow	L	Н	н		
Х	Н	L	Χ	Q ₀ ‡		
Х	L	L	Χ	Q ₀ ‡ Q ₀ ‡		
Х	X	Н	L	L		
Х	Х	Н	Н	Н		

[†] A-port register shown. B and C ports are similar but use CLKENB, CLKENC, CLKB, CLKC, LEB, and LEC.

A-PORT OUTPUT

INP	UTS	OUTPUT A			
OEA	SELA				
Н	Χ	Z			
L	Н	Output of C register			
L	L	Output of B register			

B-PORT OUTPUT

	INP	UTS	OUTPUT D			
	OEB	SELB	OUTPUT B			
Γ	Н	Χ	Z			
	L	Н	Output of A register			
	L	L	Output of C register			

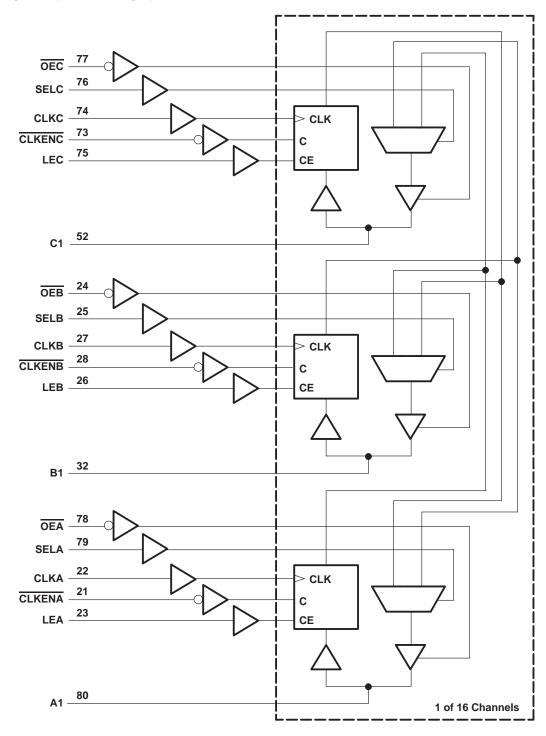
C-PORT OUTPUT

INP	UTS	OUTPUT C			
OEC	SELC	OUTPUT C			
Н	Х	Z			
L	Н	Output of B register			
L	L	Output of A register			



[‡]Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



Pin numbers shown are for the PN package.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABTH32316	96 mA
SN74ABTH32316	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	
Package thermal impedance, θ _{JA} (see Note 2): PN package	62°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		!		H32316	SN74ABTH32316		UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	Vcc	V
IOH	High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TECT COME	NTIONS	SN54	4ABTH3	2316	SN74	ABTH32	2316	UNIT	
"	ARAMETER	TEST COND	IIIONS	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNII	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V	
		V _{CC} = 4.5 V,	$I_{OH} = -3 \text{ mA}$	2.5			2.5				
\/~		V _{CC} = 5 V,	$I_{OH} = -3 \text{ mA}$	3			3			v	
VOH		V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2						V	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$				2				
VOL		V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55				V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$						0.55	V	
V _{hys}					100			100		mV	
1.	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$ $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1			±1		
1	A, B, or C ports		$V_I = V_{CC}$ or GND			±100			±20	μΑ	
lan an	A D == 0 ====== V	V _{CC} = 4.5 V	V _I = 0.8 V	100			100			μΑ	
l(hold)	A, B, or C ports		V _I = 2 V	-100			-100				
lozpu [‡]	‡	$V_{CC} = 0$ to 2.1 V, $V_{O} = 0.5$	5 V to 2.7 V, OE = X			±50			±50	μΑ	
lozpd ²	‡	$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5$	5 V to 2.7 V, OE = X			±50			±50	μΑ	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100			±100	μΑ	
ICEX		$V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$	Outputs high			50			50	μΑ	
IO§		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-100	-180	mA	
		V _{CC} = 5.5 V,	Outputs high			2			2		
ICC		$I_{O} = 0$,	Outputs low			40			40	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			1			1		
ΔICC¶		V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				1			0.5	mA	
Ci	Control inputs	V _I = 2.5 V or 0.5 V	V _I = 2.5 V or 0.5 V		3			3		pF	
C _{io}	A, B, or C ports	V _O = 2.5 V or 0.5 V			11.5			11.5		pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

				H32316	SN74ABTI	UNIT	
			MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	150	0	150	MHz
	t _W Pulse duration	LE high	3.3		3.3		no
١W		CLK high or low	3.3		3.3		ns
		A, B, or C before CLK↑	2.6		2.4		
t _{su}	t _{SU} Setup time	A or B before LE↓	2.5		2.1		ns
		CLKEN before CLK↑	3.5		3.2		
	A	A, B, or C after CLK↑	1.8		1.4		
th	Hold time	A or B after LE↓	2.4	·	2.1		ns
		CLKEN after CLK↑	1.5	·	1.1		



[‡]This parameter is specified by characterization.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

 $[\]P$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

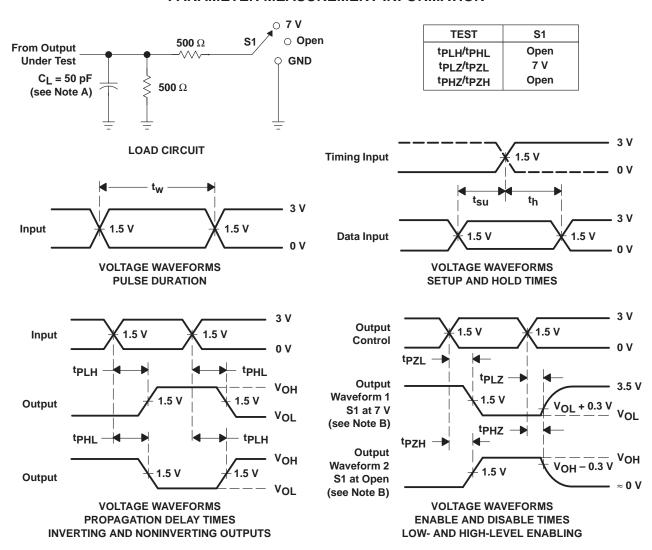
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	SN54ABT	H32316	SN74ABTI	H32316	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNIT
fmax			150		150		MHz
^t PLH	A, B, or C	C, B, or A	0.8	6.5	1.4	6.1	ns
t _{PHL}	A, B, or C	C, B, Ol A	0.5	6.8	1.1	6.6	115
^t PLH	SEL	A, B, or C	0.8	6.7	1.4	6.5	ns
^t PHL	JEL	A, B, Ol C	0.8	6.8	1.8	6.5	115
^t PLH	LE	A, B, or C	1.5	8	2.6	7.5	ns
^t PHL		A, B, OI C	1.5	7.4	2.6	6.9	115
^t PLH	CLK	A, B, or C	1.5	8	2.5	7.5	ns
^t PHL	CLK	A, B, OI C	1.5	7.2	2.5	6.7	115
^t PZH	ŌĒ	A, B, or C	0.8	6.7	1.5	6.4	ns
t _{PZL}	OE	A, B, O C	1.5	7.1	2.4	6.8	115
^t PHZ	ŌĒ	A, B, or C	0.8	7.2	1.5	6	nc
tPLZ	7	A, B, 01 C	0.8	6.4	1.9	6.1	ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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